

7.62mm (0.3INCH) DUAL DIGIT NUMERIC DIS-PLAY

Part Number: DC03-11EWA

High Efficiency Red

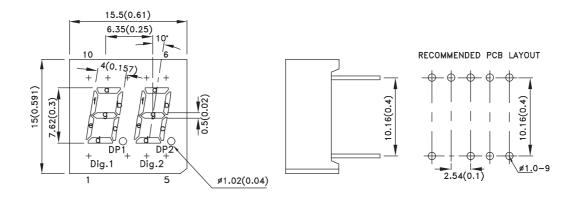
Features

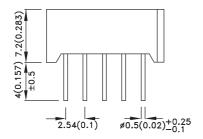
- 0.3 inch digit height.
- Low current operation.
- Excellent character appearance.
- Easy mounting on P.C. boards or sockets.
- Two digit package simplifies alignments & assembly.
- Mechanically rugged.
- Standard : gray face, white segment.
- RoHS compliant.

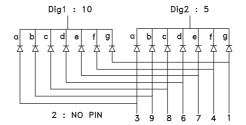
Description

The High Efficiency Red source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Orange Light Emitting Diode.

Package Dimensions& Internal Circuit Diagram











Notes

- 1. All dimensions are in millimeters (inches), Tolerance is ±0.25(0.01")unless otherwise noted.
- 2. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

 SPEC NO: DSAA3229
 REV NO: V.19A
 DATE: AUG/19/2014
 PAGE: 1 OF 6

 APPROVED: WYNEC
 CHECKED: Joe Lee
 DRAWN: Y.Liu
 ERP: 1302000276

Selection Guide

Part No.	Dice	Lens Type	lv (ucd) [1] @ 10mA		Description
			Min.	Тур.	-
DC03-11EWA	High Efficiency Red (GaAsP/GaP)	White Diffused	1400	3100	Common Cathode
			*360	*800	

Notes:

- Luminous intensity/ luminous Flux: +/-15%.
 * Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	High Efficiency Red	627		nm	IF=20mA
λD [1]	Dominant Wavelength	High Efficiency Red	617		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	High Efficiency Red	45		nm	IF=20mA
С	Capacitance	High Efficiency Red	15		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	High Efficiency Red	2.0	2.5	V	IF=20mA
lR	Reverse Current	High Efficiency Red		10	uA	V _R =5V

Notes:

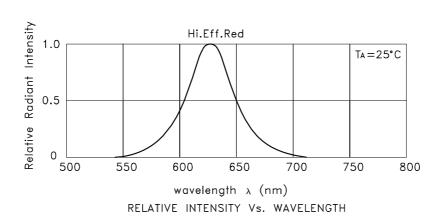
- 1.Wavelength: +/-1nm.
 2. Forward Voltage: +/-0.1V.
 3. Wavelength value is traceable to the CIE127-2007 compliant national standards.

Absolute Maximum Ratings at TA=25°C

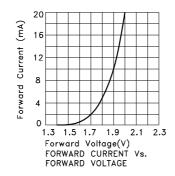
Parameter	High Efficiency Red	Units		
Power dissipation	75	mW		
DC Forward Current	30	mA		
Peak Forward Current [1]	160	mA		
Reverse Voltage	5	V		
Operating / Storage Temperature	-40°C To +85°C			
Lead Solder Temperature[2]	260°C For 3-5 Seconds			

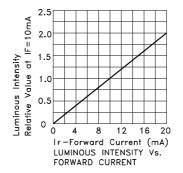
- 1. 1/10 Duty Cycle, 0.1ms Pulse Width.
- 2. 2mm below package base.

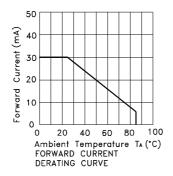
DATE: AUG/19/2014 SPEC NO: DSAA3229 **REV NO: V.19A** PAGE: 2 OF 6 APPROVED: WYNEC DRAWN: Y.Liu **CHECKED:** Joe Lee ERP: 1302000276

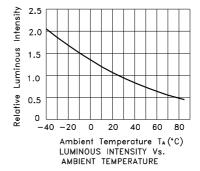


High Efficiency Red DC03-11EWA









 SPEC NO: DSAA3229
 REV NO: V.19A
 DATE: AUG/19/2014
 PAGE: 3 OF 6

 APPROVED: WYNEC
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PACKING & LABEL SPECIFICATIONS DC03-11EWA INSIDE LABEL 32PCS/TUBE OUTSIDE LABEL 110 TUBE/BOX 3520PCS/BOX Inside Label on IC-Tube TYPE: Dx03-11xxx QTY: 32 PCS CODE: xx Kingbright PASSED FQCX Number OF FQC RoHS Compliant LOT NO. Outside Label on Box XXXXXX Number OF QA Dx03-11xxx Bin Code 3520 PCS

Terms and conditions for the usage of this document

1. The information included in this document reflects representative usage scenarios and is intended for technical reference only.

QAx

PASSED RoHS Compliant

Date

- 2. The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
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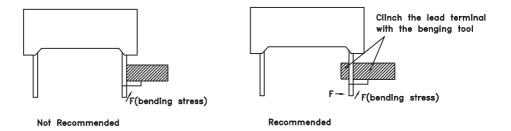
 SPEC NO: DSAA3229
 REV NO: V.19A
 DATE: AUG/19/2014
 PAGE: 4 OF 6

 APPROVED: WYNEC
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THROUGH HOLE DISPLAY MOUNTING METHOD

Lead Forming

Do not bend the component leads by hand without proper tools. The leads should be bent by clinching the upper part of the lead firmly such that the bending force is not exerted on the plastic body.

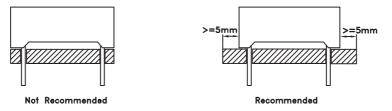


Installation

- 1. The installation process should not apply stress to the lead terminals.
- 2. When inserting for assembly, ensure the terminal pitch matches the substrate board's hole pitch to prevent spreading or pinching the lead terminals.



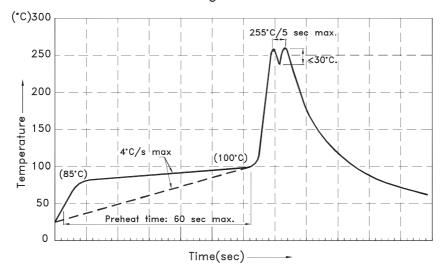
3. The component shall be placed at least 5mm from edge of PCB to avoid damage caused excessive heat during wave soldering.



 SPEC NO: DSAA3229
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Recommended Wave Soldering Profiles:



Notes:

- 1.Recommend pre—heat temperature of 105°C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of 260°C
- 2.Peak wave soldering temperature between 245°C \sim 255°C for 3 sec (5 sec max).
- 3.Do not apply stress to the epoxy resin while the temperature is above 85°C.
- 4.Fixtures should not incur stress on the component when mounting and during soldering process. 5.SAC 305 solder alloy is recommended.
- 6.No more than one wave soldering pass.
- 7.During wave soldering, the PCB top-surface temperature should be kept below 105°C.

Soldering General Notes:

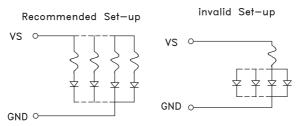
- 1. Through—hole displays are incompatible with reflow soldering.
- 2. If components will undergo multiple soldering processes, or other processes where the components may be subjected to intense heat, please check with Kingbright for compatibility.

CLEANING

- 1.Mild "no-clean" fluxes are recommended for use in soldering.
- 2. If cleaning is required, Kingbright recommends to wash components with water only. Do not use harsh organic solvents for cleaning, because they may damage the plastic parts .And the devices should not be washed for more than one minute.

CIRCUIT DESIGN NOTES

- 1.Protective current—limiting resistors may be necessary to operate the Displays.
- 2.LEDs mounted in parallel should each be placed in series with its own current—limiting resistor.



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